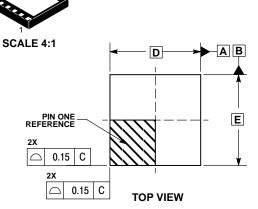
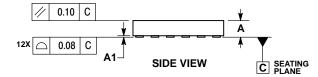
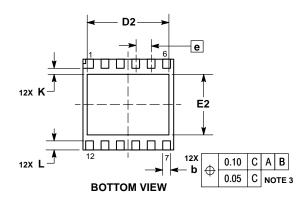
semi

LLGA12 3x3, 0.5P CASE 513AK ISSUE O







DATE 28 JUN 2007

- NOTES: 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. 2. 3.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.30 MM FROM TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. 4

| | MILLIMETERS | | | |
|-----|-------------|------|--|--|
| DIM | MIN | MAX | | |
| Α | 0.50 | 0.60 | | |
| A1 | 0.00 | 0.05 | | |
| b | 0.20 | 0.30 | | |
| D | 3.00 BSC | | | |
| D2 | 2.60 | 2.80 | | |
| Е | 3.00 BSC | | | |
| E2 | 1.90 | 2.10 | | |
| е | 0.50 BSC | | | |
| Κ | 0.20 | | | |
| L | 0.25 | 0.35 | | |
| | | | | |

GENERIC **MARKING DIAGRAM***

- XXXXX XXXXX ALYW=
- = Assembly Location
- = Wafer Lot
- = Year

А

L

Y

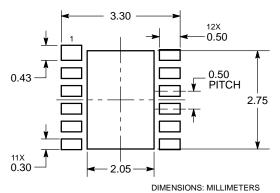
W

- = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------------------------|---|-------------|
| DESCRIPTION: | 12 PIN LLGA, 3 X 3 X 0.55T, 0.5P | | PAGE 1 OF 1 |
| | | | |

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